

**Plastic Silicon Rectifiers****Features**

- Low cost
- Low reverse leakage current
- Low forward voltage drop
- High surge capacity
- Meet UL flammability classification 94V-0

Mechanical Data

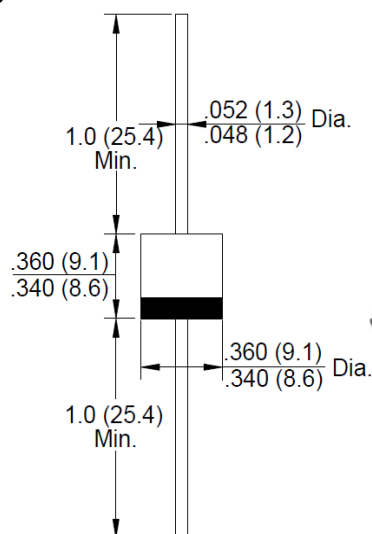
- Case: JEDEC R-6 molded plastic
- Polarity: Color band denotes cathode
- Mounting position: Any

Note: Products with logo  or  are made by HY Electronic (Cayman) Limited.

Applications

- For use in low voltage, high frequency inverters, polarity protection applications

Reverse Voltage - 50 to 1000Volts
Forward Current - 6.0 Amperes

R-6RoHS
COMPLIANT

Package Outline Dimensions in Inches (Millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristics	Symbol	P600A	P600B	P600D	P600G	P600J	P600K	P600M	Unit
Maximum Repetitive Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @TA=60 °C	I(AV)	6.0							A
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave, Superimposed on Rated Load (JEDEC Method)	IFSM	300							A
I²t Rating for Fusing (t<8.3mS)	I²t	373							A²s
Peak Forward Voltage at 6.0A DC (Note1)	VF	1.0							V
Maximum DC Reverse Current @TJ=25°C	IR	10							uA
at Rated DC Blocking Voltage @TJ=100°C		100							
Typical Junction Capacitance (Note 2)	CJ	100							pF
Typical Thermal Resistance Junction to Ambient	RθJA	10							°C/W
Operating Junction Temperature Range	TJ	-55 to+150							°C
Storage Temperature Range	TSTG	-55 to+150							°C

Notes: 1. 300uS pulse width, 2%duty cycle.

2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

3. The typical data above is for reference only .



Fig. 1 - Forward Current Derating Curve

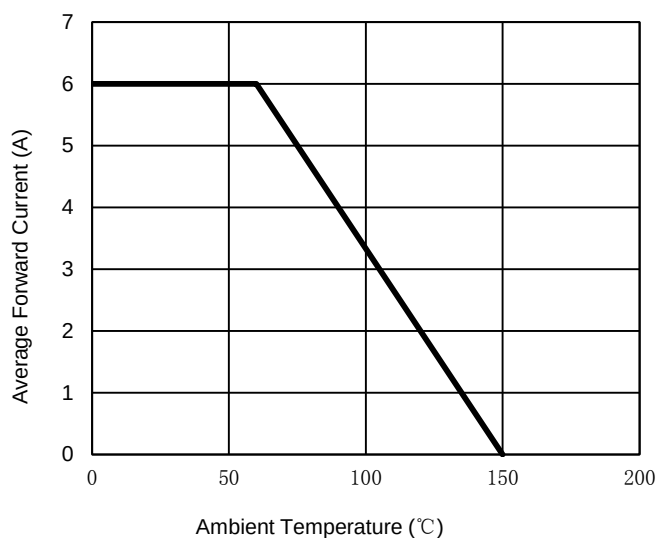


Fig. 2 - Maximum Non-Repetitive Surge Current

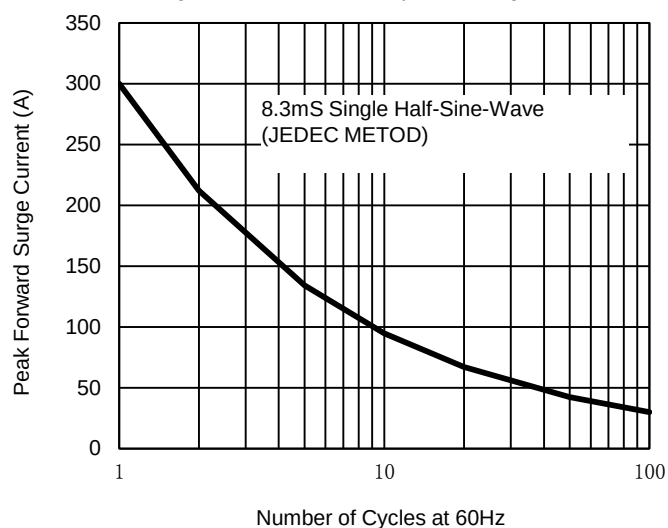


Fig. 3 - Typical Reverse Characteristics

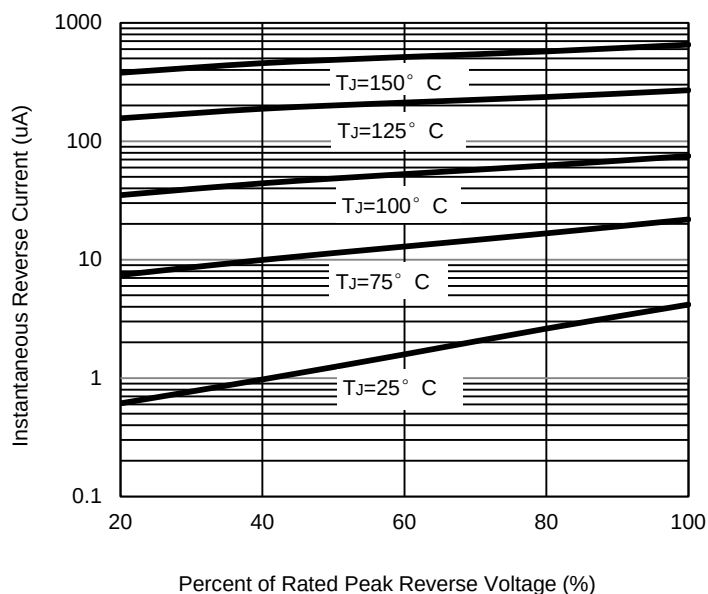


Fig. 4 - Typical Forward Characteristics

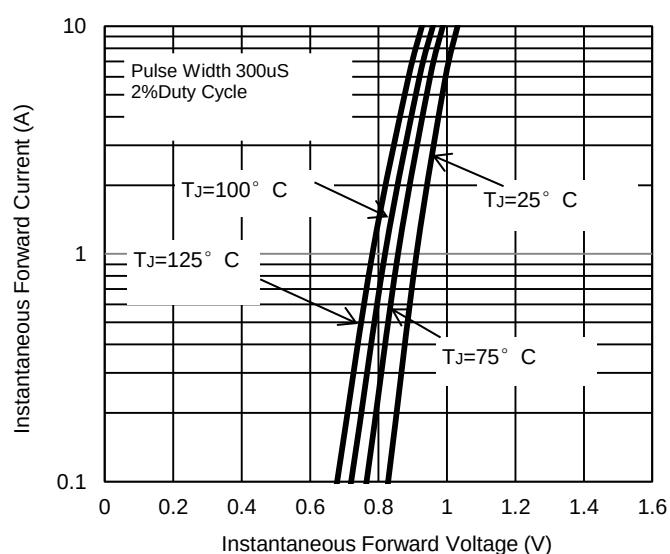
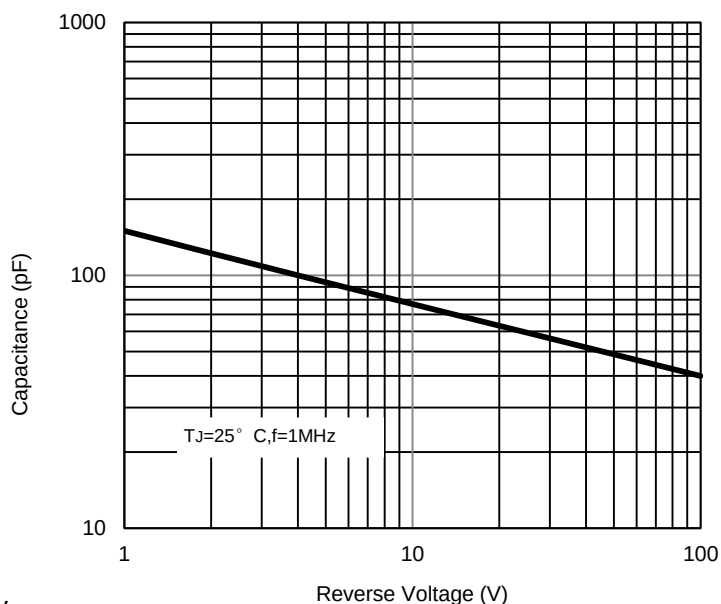


Fig. 5 - Typical Junction Capacitance



The curve above is for reference only.



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